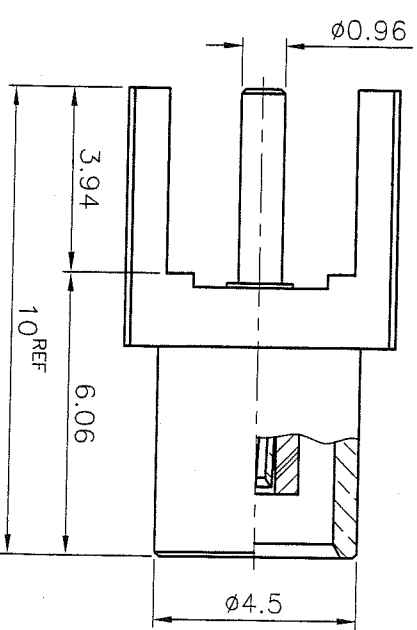
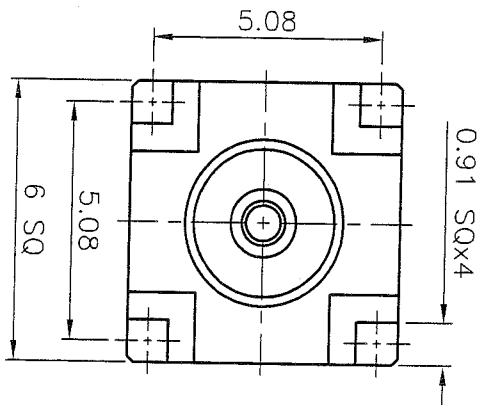
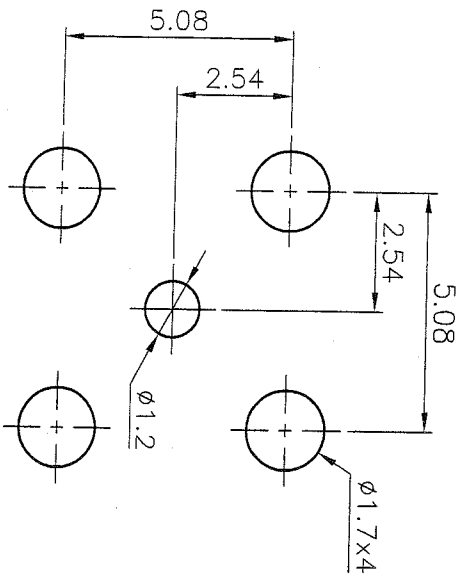


ISS	SYMBOL	REVISIONS	DESCRIPTION\DATE
-----	--------	-----------	------------------

REMARK: RoHS COMPLIANT
(符合 RoHS)

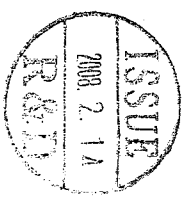
FOR CUSTOMER



P.C.B. LAYOUT
(印刷电路板配置)

- NOTES: FINISH (PLATING THICKNESS IN MICRO-INCHES)
1. BRASS PER QQ-B-626
 2. GOLD PL 3 MIN OVER NICKEL PL 70 MIN THICK OVER COPPER STRIKE
 3. GOLD PL 30 MIN OVER NICKEL PL 70 MIN THICK OVER COPPER STRIKE
 4. TEFLON MIL-P-19468
 5. BERYLLIUM COPPER PER QQ-C-530

DIMENSIONS ARE IN MILLIMETERS		UNLESS OTHERWISE SPECIFIED		PART NO.		APPROVED		DATE		DRAWING NO.	
TOLERANCES (一般公差)		0.5~6 = ±0.2				<i>[Signature]</i>		08/03/06		BO-JIANG	
		>6~30 = ±0.4				<i>[Signature]</i>		08/03/06		B0-JIANG TECHNOLOGY CO., LTD.	
		>30~120 = ±0.6				<i>[Signature]</i>		08/03/06		TITLE	
		>120~315 = ±1				<i>[Signature]</i>		08/03/06		MCX PCB MOUNT JACK	
		>315~1000 = ±1.6				<i>[Signature]</i>		08/03/06		DRAWING NO.	
ANGLES(角度) = ±5'						<i>[Signature]</i>		08/03/06		9665NSS502BDD000B	
SCALE		6/1		ISSUE		A1				FILE NO. Z:\NND\9665\NS\502\000\BDB-A1	
NO.		DESCRIPTION		MATERIAL		FINISH		QTY		DRAWING NO.	
		CONTACT PIN		NOTE 5		NOTE 3					
		INSULATOR		NOTE 4		WHITE					
		BODY		NOTE 1		NOTE 2					



3 昂江科技股份有限公司
B0-JIANG B0-JIANG TECHNOLOGY CO., LTD.
MCX PCB MOUNT JACK